

Docket No. 215899US90PCT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yasuji HIRAMATSU, et al.

SERIAL NO: 09/926,499

GAU: 1772

RCE FILED: November 17, 2003

EXAMINER: Jane J. Rhee

FOR: CERAMIC SUBSTRATE

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Registration No. 43,922



LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/Applicant</u>
PER CLIENT	10/345,356	01/16/03	ITO
PER CLIENT	10/182,009	07/24/02	ZHOU
PER CLIENT	10/222,928	08/19/02	ITO
PER CLIENT	10/265,413	10/07/02	OHASHI et al.
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217827US90 PCT	10/019,444	04/23/02	HIRAMATSU et al.
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Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 215899US90PCT		SERIAL NO. 09/926,499	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Yasuji HIRAMATSU, et al.			
				RCE FILING DATE November 17, 2003		GROUP 1772	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER PATENT / TRADEMARK	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
AA		2003/0054147	03/20/03	Niwa			
AB		2003/0015521	01/23/03	Ito			
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		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION		
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AP		1 225 790	07/24/02	Europe (in English language)			
AQ		0 963 137	12/08/99	Europe (in English language)			
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OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
AW		Akio Igawa, "The Present Situation and Problems of Helium Leak Detector", Semiconductor World, November 1992, pages 111-115 (in Japanese, translation attached)					
AX							
AY							
AZ							<input type="checkbox"/> Additional References sheet(s) attached
Examiner				Date Considered			
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							